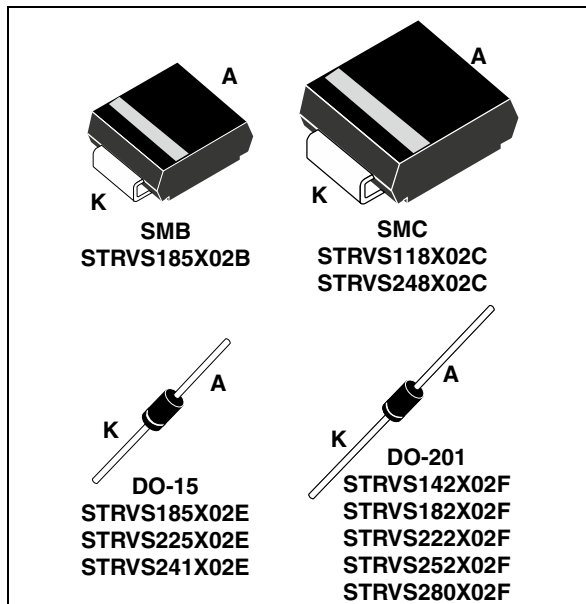


ST repetitive voltage suppressor

Datasheet – production data



Features

- Clamping voltage characteristics defined at 25 °C, 85 °C and 125 °C
- Stand-off voltage range: from 85 V to 188 V
- Low leakage current: 0.2 μ A at 25 °C
- Maximum operating junction temperatures:
 - SMB and SMC: 150 °C
 - DO-15 and DO-201: 175 °C

Complies with the following standards:

- IEC 61000-4-2 level 4
 - \pm 15 kV (air discharge)
 - \pm 8 kV (contact discharge)
- IEC 61000-4-5 level 4
- MIL-STD-883, method 3015, class 3B:
 - 25 kV HBM (human body model)
- MIL-STD-750, method 2026 solderability
- EIA STD RS-481 and IEC 60286-3 packing (surface mount packages)

Applications

- MOSFET protection
- IGBT protection
- Auxiliary power supply

Description

The STRVSX series is a TVS family created to provide simple and effective solutions for designers working on circuits that require protection from repetitive overvoltages.

The STRVSX series is highly reliable and suits applications where the surge frequency makes the protected device temperature increase, for example, MOSFET protection in fly back configuration.

Additional support for designers using these devices is available in the STMicroelectronics application note AN4209: "Design methodology for repetitive voltage suppressors (RVS) in repetitive mode: STRVS".

Table 1. Device summary

| CPN | Clamping voltage $I_{PP} = 2 \text{ A (125 } ^\circ)$ | Package |
|--------------|--|---------|
| STRVS118X02C | 118 V | SMC |
| STRVS142X02F | 142 V | DO-201 |
| STRVS182X02F | 182 V | DO-201 |
| STRVS185X02B | 185 V | SMB |
| STRVS182X02E | 185 V | DO-15 |
| STRVS222X02F | 222 V | DO-201 |
| STRVS225X02E | 225 V | DO-15 |
| STRVS241X02E | 241 V | DO-15 |
| STRVS248X02C | 248 V | SMC |
| STRVS252X02F | 252 V | DO-201 |
| STRVS280X02F | 280 V | DO-201 |

1 Characteristics

Table 2. Absolute maximum ratings ($T_{amb} = 25\text{ °C}$)

| Symbol | Parameter | Value | Unit |
|-----------|---|------------|------|
| T_j | Operating junction temperature range (SMB and SMC) | -55 to 150 | °C |
| | Operating junction temperature range (DO-15 and DO-201) | -55 to 175 | °C |
| T_{stg} | Storage temperature range (SMB and SMC) | -65 to 150 | °C |
| | Storage temperature range (DO-15 and DO-201) | -65 to 175 | °C |
| T_L | Maximum lead temperature for soldering during 10 s (SMB and SMC) | 260 | °C |
| | Maximum lead temperature for soldering during 10 s at 5 mm from case (DO-15 and DO-201) | 260 | °C |

Table 3. Thermal resistances

| Symbol | Parameter | Value | Unit | |
|---------------|------------------------------------|--------|------|------|
| $R_{th(j-l)}$ | Junction to leads | SMB | 13 | °C/W |
| | | SMC | 12 | |
| | | DO-15 | 35 | |
| | | DO-201 | 23 | |
| $R_{th(j-a)}$ | Junction to ambient ⁽¹⁾ | SMB | 185 | |
| | | SMC | 150 | |
| | | DO-15 | 105 | |
| | | DO-201 | 100 | |

1. On printed circuit with recommended pad layout

Figure 1. Electrical characteristics - definitions

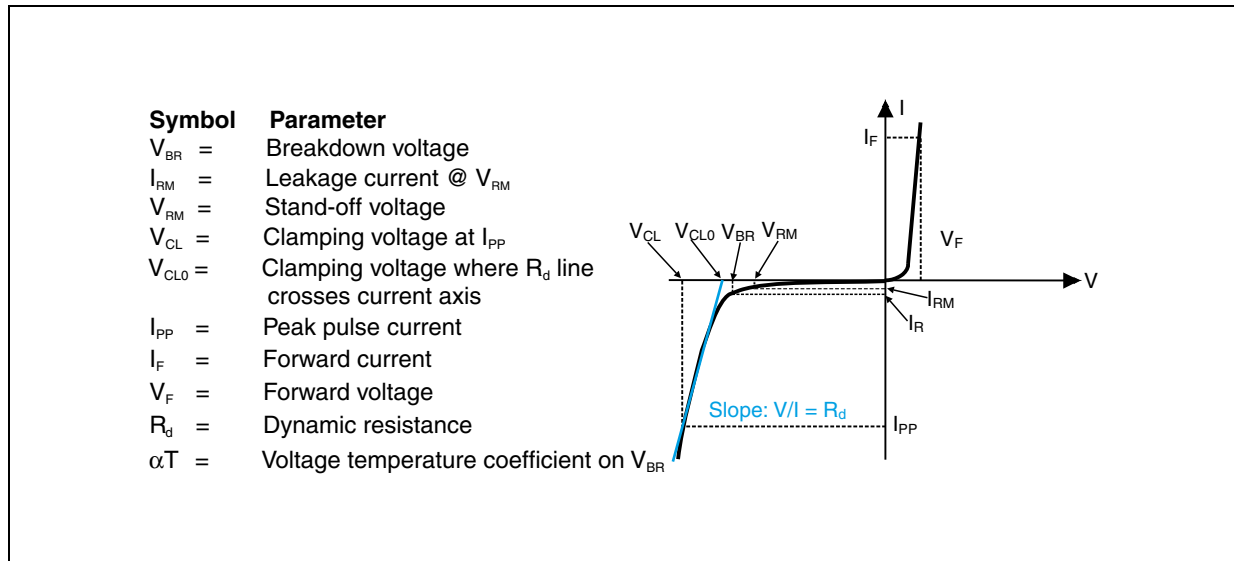


Table 4. Electrical characteristics - values

| Order code | $I_{RM} \text{ max @ } V_{RM}$ (25 °C) | | $V_{BR} \text{ @ } I_R^{(1)} \text{ (25 °C)}$ | | Values @ 125 °C (typ.) | | | | αT | |
|----------------|---|-----|---|------|------------------------|----------------------------|-----------|-------------|------------|---------------------|
| | | | Min. | Max. | I_{PP} | $V_{CL} \text{ @ } I_{pp}$ | V_{CL0} | $R_d^{(2)}$ | Max. | |
| | μA | V | V | | mA | A | V | V | Ω | $10^{-4}/^{\circ}C$ |
| STRVS118X02C | 0.2 | 85 | 95 | 105 | 1 | 2 | 118 | 116 | 1.0 | 10.6 |
| STRVS142X02F | 1 | 102 | 114 | 126 | 1 | 2 | 142 | 140 | 1.0 | 10.7 |
| STRVS182X02F | 1 | 128 | 143 | 158 | 1 | 2 | 182 | 177 | 2.5 | 10.8 |
| STRVS185X02B/E | 0.2 | 128 | 143 | 158 | 1 | 2 | 185 | 178 | 2.5 | 10.8 |
| STRVS222X02F | 1 | 154 | 171 | 189 | 1 | 2 | 222 | 213 | 4.5 | 10.8 |
| STRVS225X02E | 0.5 | 154 | 171 | 189 | 1 | 2 | 225 | 214 | 5.5 | 10.8 |
| STRVS241X02E | 0.5 | 171 | 190 | 210 | 1 | 2 | 241 | 234 | 3.5 | 10.8 |
| STRVS248X02C | 0.5 | 171 | 190 | 210 | 1 | 2 | 248 | 238 | 5.0 | 10.8 |
| STRVS252X02F | 1 | 171 | 190 | 210 | 1 | 2 | 252 | 239 | 6.5 | 10.8 |
| STRVS280X02F | 1 | 188 | 209 | 231 | 1 | 2 | 280 | 263 | 8.5 | 10.8 |

1. To calculate V_{BR} at a given junction temperature, use the following formula: $V_{BR} \text{ @ } T_j = V_{BR} \text{ @ } 25 \text{ °C} \times (1 + \alpha T \times (T_j - 25))$

2. $R_d = (V_{CL} - V_{CL0})/I_{PP}$

Figure 2. Clamping voltage versus peak pulse current - STRVS118X02C (typical values)

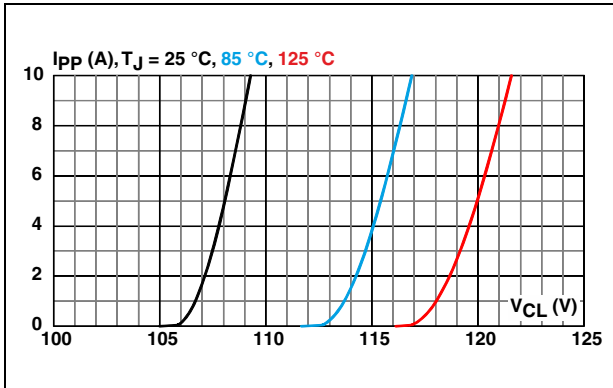


Figure 3. Clamping voltage versus peak pulse current - STRVS142X02F (typical values)

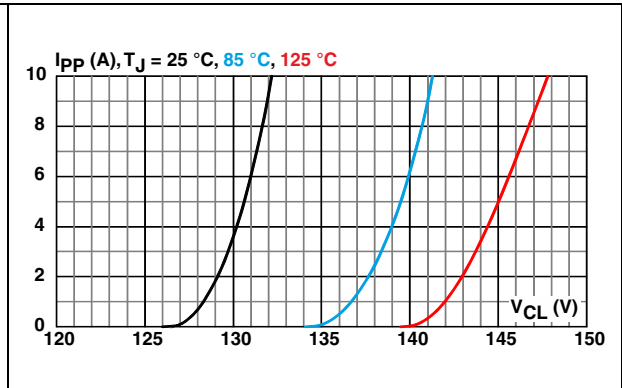


Figure 4. Clamping voltage versus peak pulse current - STRVS182X02F (typical values)

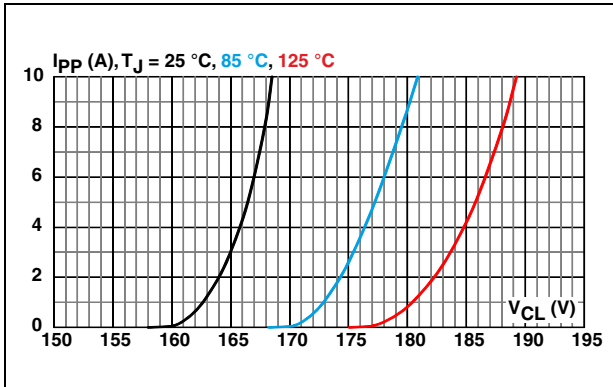


Figure 5. Clamping voltage versus peak pulse current - STRVS185X02B/E (typical values)

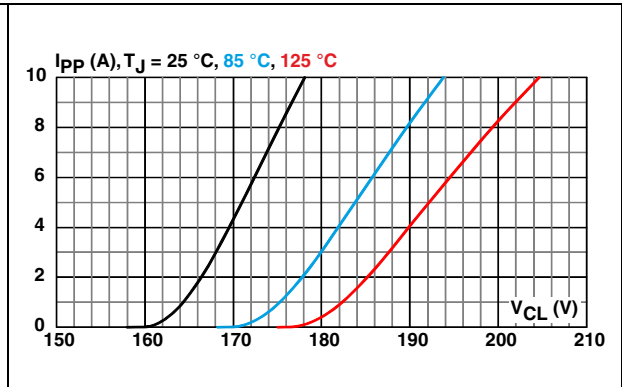


Figure 6. Clamping voltage versus peak pulse current - STRVS222X02F (typical values)

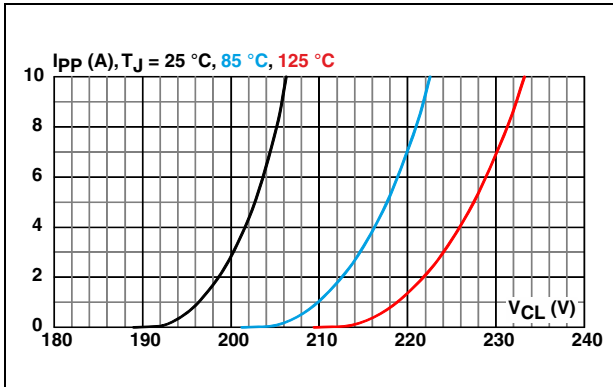


Figure 7. Clamping voltage versus peak pulse current - STRVS225X02E (typical values)

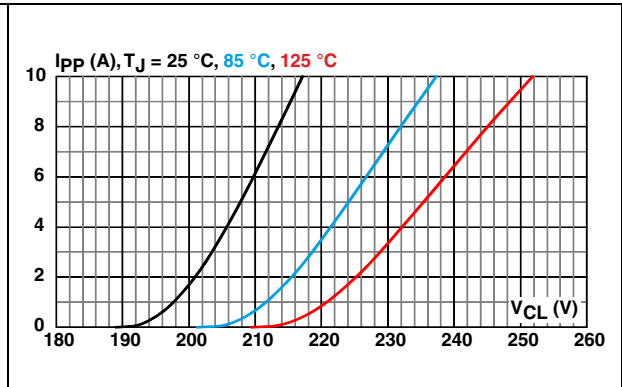


Figure 8. Clamping voltage versus peak pulse current - STRVS241X02E (typical values)

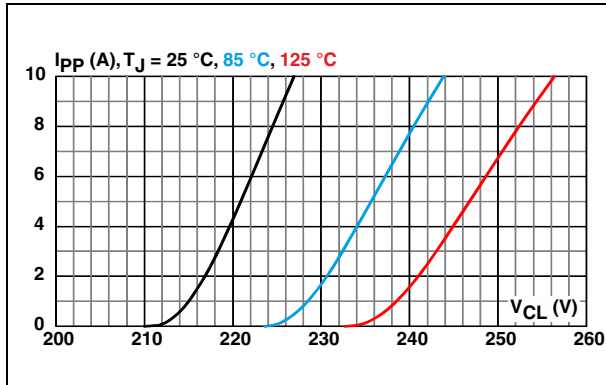


Figure 9. Clamping voltage versus peak pulse current - STRVS248X02C (typical values)

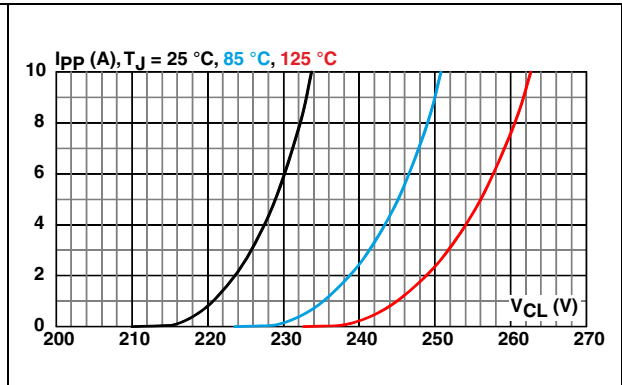


Figure 10. Clamping voltage versus peak pulse current - STRVS252X02F

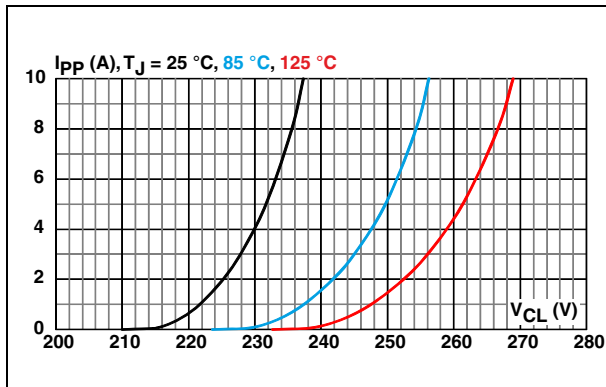


Figure 11. Clamping voltage versus peak pulse current - STRVS280X02F

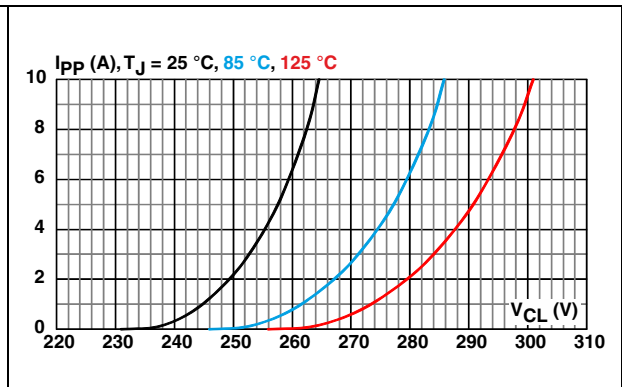


Figure 12. Leakage current versus junction temperature (typical values) STRVSxxxC

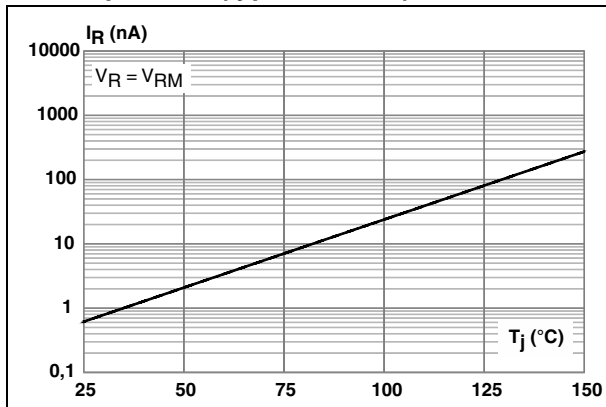


Figure 13. Leakage current versus junction temperature (typical values) STRVSxxxF

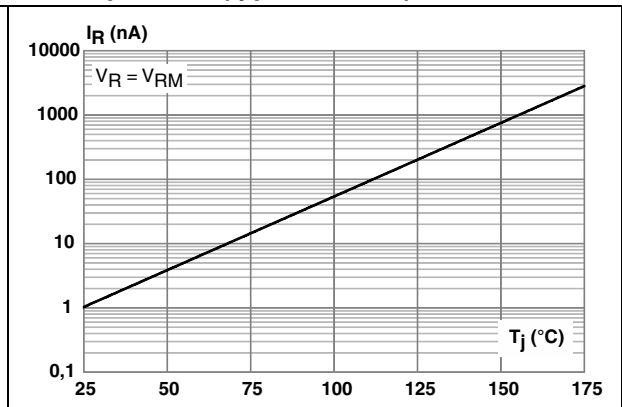


Figure 14. Leakage current versus junction temperature (typical values) STRVSxxxB

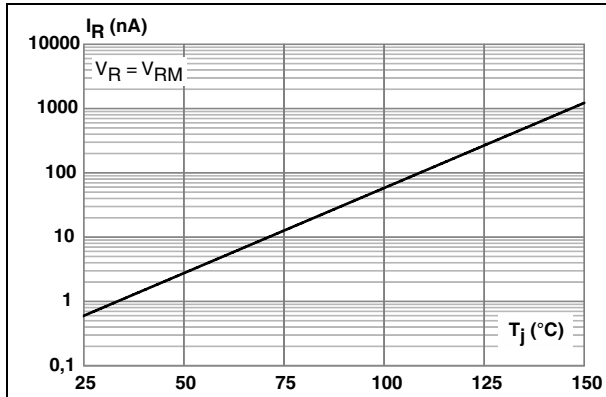


Figure 15. Leakage current versus junction temperature (typical values) STRVSxxxE

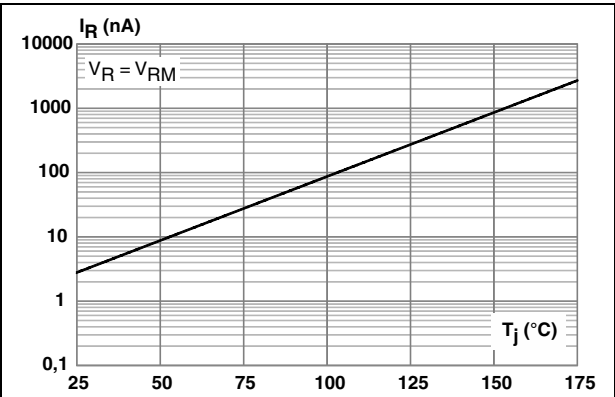


Figure 16. Thermal resistance junction to ambient versus copper surface of connections - SMB

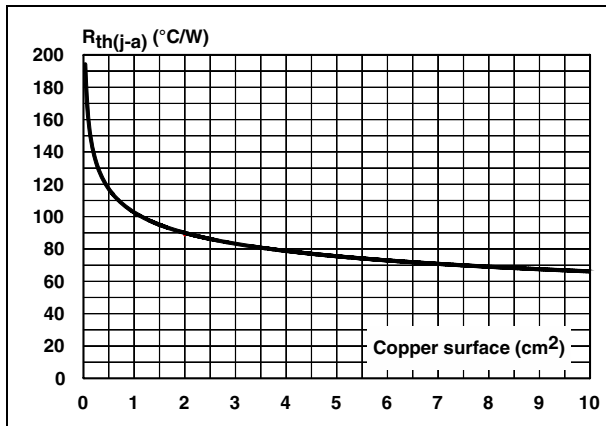


Figure 17. Thermal resistance junction to ambient versus copper surface of connections - SMC

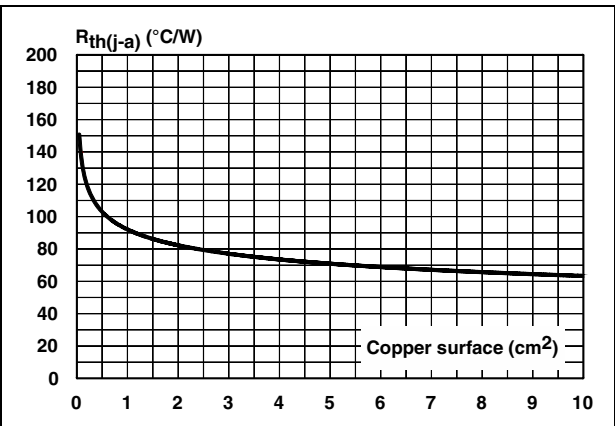


Figure 18. Thermal resistance junction to ambient versus copper surface of connections - DO-15

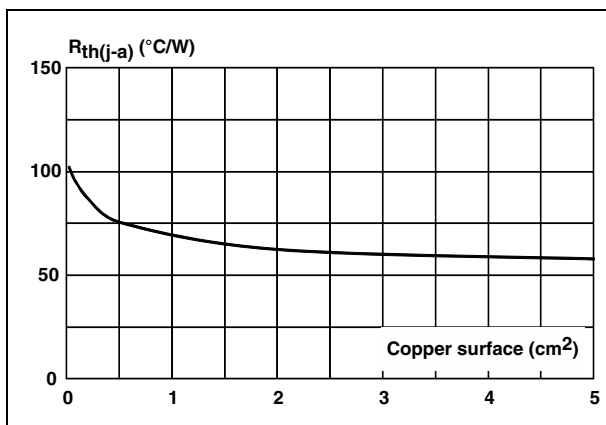
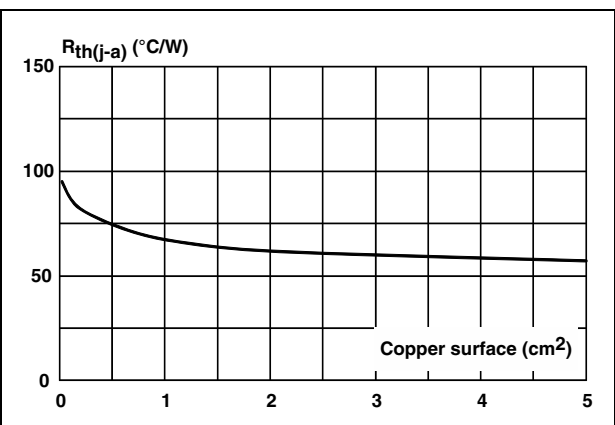


Figure 19. Thermal resistance junction to ambient versus copper surface of connections - DO-201



2 Package information

- Epoxy meets UL94, V0
- Lead-free package
- Polarity: band indicates cathode
- Terminals: solder plated, solderable as per MIL-STD-750, method 2026

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Figure 20. SMB dimension definitions

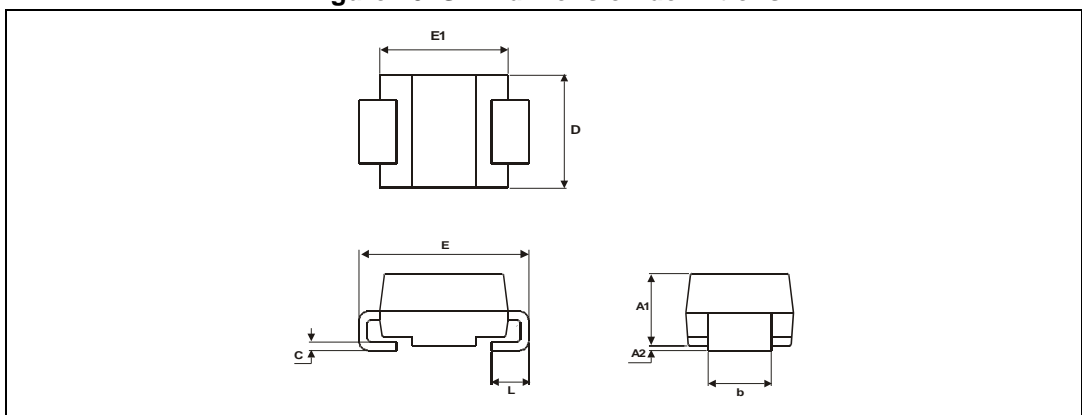


Table 5. SMB dimension values

| Ref. | Dimensions | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.075 | 0.096 |
| A2 | 0.05 | 0.20 | 0.002 | 0.008 |
| b | 1.95 | 2.20 | 0.077 | 0.087 |
| c | 0.15 | 0.40 | 0.006 | 0.016 |
| D | 3.30 | 3.95 | 0.130 | 0.156 |
| E | 5.10 | 5.60 | 0.201 | 0.220 |
| E1 | 4.05 | 4.60 | 0.159 | 0.181 |
| L | 0.75 | 1.50 | 0.030 | 0.059 |

Figure 21. SMB Footprint, dimensions in mm (inches)

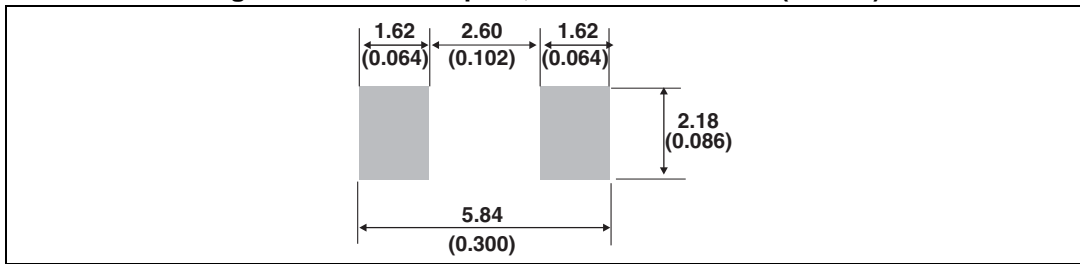


Figure 22. SMB marking layout

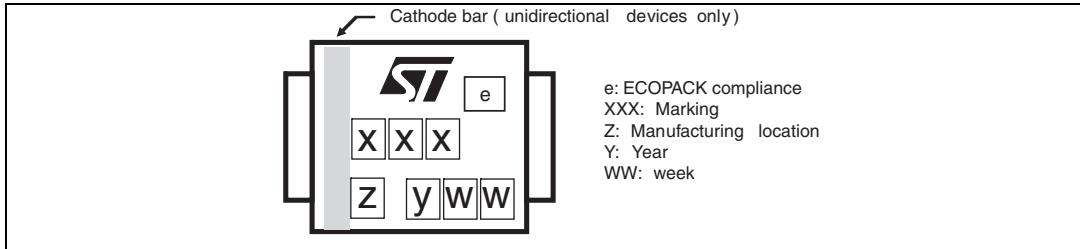


Figure 23. SMC dimension definitions

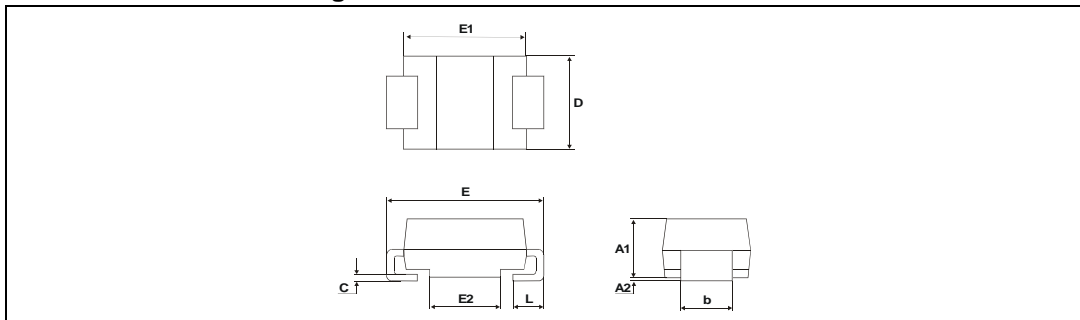


Table 6. SMC dimension values

| Ref. | Dimensions | | | |
|------------------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A1 | 1.90 | 2.45 | 0.075 | 0.096 |
| A2 | 0.05 | 0.20 | 0.002 | 0.008 |
| b ⁽¹⁾ | 2.90 | 3.20 | 0.114 | 0.126 |
| c ⁽¹⁾ | 0.15 | 0.40 | 0.006 | 0.016 |
| D | 5.55 | 6.25 | 0.218 | 0.246 |
| E | 7.75 | 8.15 | 0.305 | 0.321 |
| E1 | 6.60 | 7.15 | 0.260 | 0.281 |
| E2 | 4.40 | 4.70 | 0.173 | 0.185 |
| L | 0.75 | 1.50 | 0.030 | 0.059 |

1. Dimensions b and c apply to plated leads

Figure 24. SMC footprint, dimensions in mm (inches)

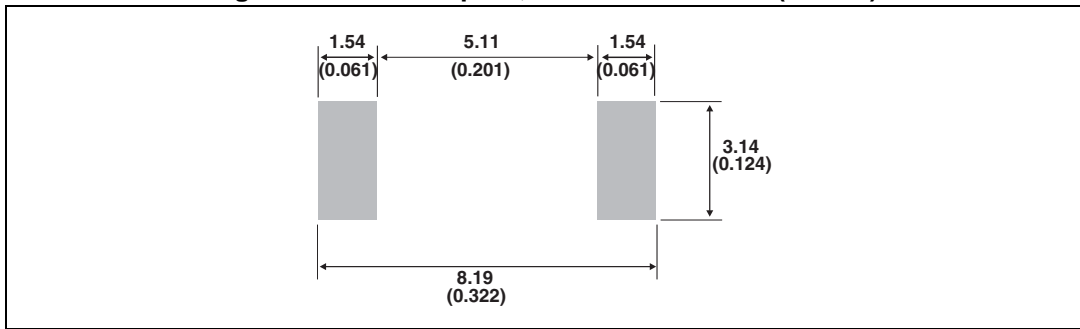


Figure 25. SMC marking layout

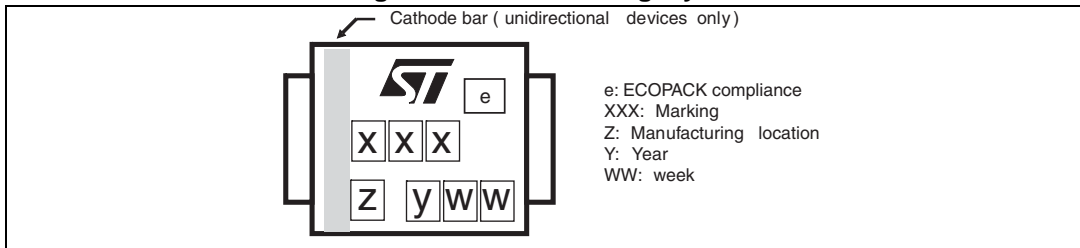


Figure 26. DO-15 dimension definitions

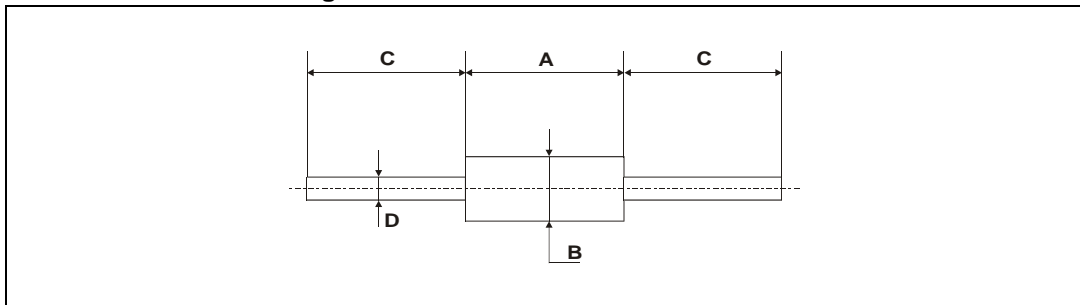


Table 7. DO-15 dimension values

| Ref. | Dimensions | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 6.05 | 6.75 | 0.238 | 0.266 |
| B | 2.95 | 3.53 | 0.116 | 0.139 |
| C | 26 | 31 | 1.024 | 1.220 |
| D | 0.71 | 0.88 | 0.028 | 0.035 |

Figure 27. DO-201 dimension definitions

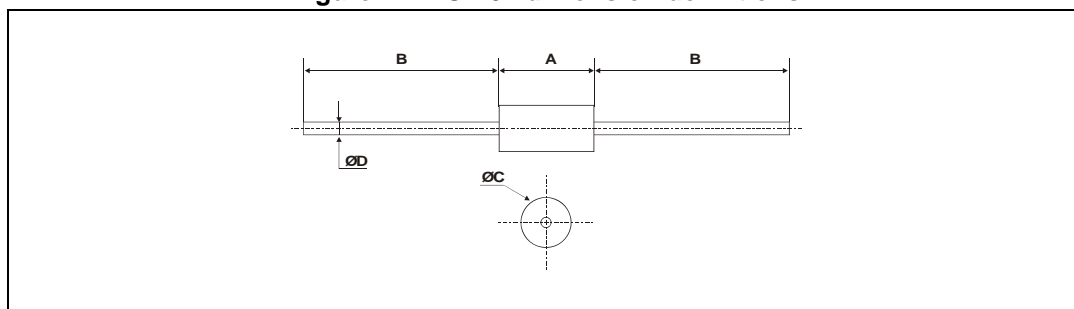


Table 8. DO-201 dimension values

| Ref. | Dimensions | | | |
|------|-------------|------|--------|-------|
| | Millimeters | | Inches | |
| | Min. | Max. | Min. | Max. |
| A | 8.5 | 9.5 | 0.335 | 0.374 |
| B | 25.4 | | 1 | |
| Ø C | 4.8 | 5.3 | 0.189 | 0.209 |
| Ø D | 0.96 | 1.06 | 0.038 | 0.042 |

3 Ordering information

Figure 28. Ordering information scheme

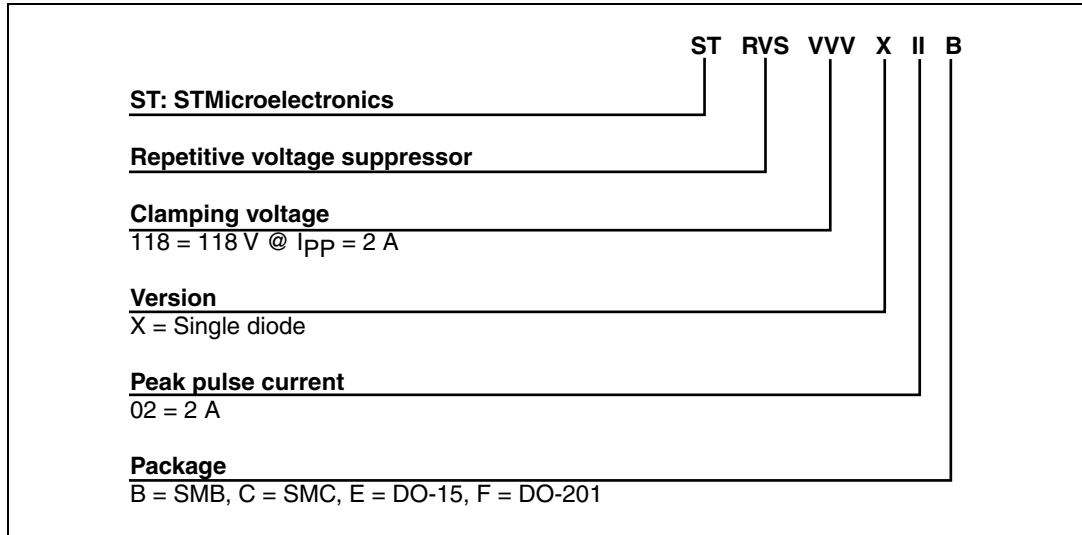


Table 9. Ordering information

| Order code | Marking | Package | Weight | Base qty. | Delivery mode |
|--------------|---------|---------|--------|-----------|---------------|
| STRVS118X02C | R118C | SMC | 0.25 g | 2500 | Tape and reel |
| STRVS142X02F | R142F | DO-201 | 0.90 g | 600 | Ammopack |
| STRVS182X02F | R182F | DO-201 | 0.90 g | 600 | Ammopack |
| STRVS185X02B | R185B | SMB | 0.12 | 2500 | Tape and reel |
| STRVS185X02E | R185E | DO-15 | 0.40 | 1000 | Ammopack |
| STRVS222X02F | R222F | DO-201 | 0.90 g | 600 | Ammopack |
| STRVS225X02E | R225E | DO-15 | 0.40 | 1000 | Ammopack |
| STRVS241X02E | R241E | DO-15 | 0.40 | 1000 | Ammopack |
| STRVS248X02C | R4248C | SMC | 0.25 g | 2500 | Tape and reel |
| STRVS252X02F | R252F | DO-201 | 0.90 g | 600 | Ammopack |
| STRVS280X02F | R280F | DO-201 | 0.90 g | 600 | Ammopack |

4 Revision history

Table 10. Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 05-Mar-2013 | 1 | Initial release. |
| 18-Apr-2013 | 2 | Insertion of Table 1 . |

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